



# PSMN3R9-60PS

N-channel 60 V, 3.9 mΩ standard level MOSFET in SOT78

1 February 2013

Product data sheet

## 1. General description

Standard level N-channel MOSFET in SOT78 using TrenchMOS technology. Product design and manufacture has been optimized for use in battery operated power tools.

## 2. Features and benefits

- High efficiency due to low switching & conduction losses
- Robust construction for demanding applications
- Standard level gate

## 3. Applications

- Battery-powered tools
- Load switching
- Motor control
- Uninterruptible power supplies

## 4. Quick reference data

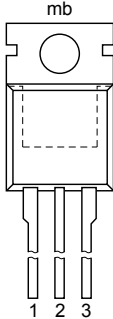
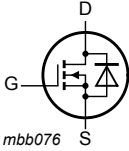
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C		-	-	60	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <a href="#">Fig. 1</a>	<a href="#">[1]</a>	-	-	130	A
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <a href="#">Fig. 2</a>		-	-	263	W
Static characteristics							
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; <a href="#">Fig. 11</a>		-	2.94	3.9	mΩ
Dynamic characteristics							
Q <sub>G(tot)</sub>	total gate charge	I <sub>D</sub> = 25 A; V <sub>DS</sub> = 48 V; V <sub>GS</sub> = 10 V; <a href="#">Fig. 13</a> ; <a href="#">Fig. 14</a>		-	103	-	nC
Q <sub>GD</sub>	gate-drain charge			-	33	-	nC
Avalanche ruggedness							
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	I <sub>D</sub> = 130 A; V <sub>sup</sub> ≤ 60 V; R <sub>GS</sub> = 50 Ω; V <sub>GS</sub> = 10 V; T <sub>J(init)</sub> = 25 °C; unclamped; <a href="#">Fig. 3</a>		-	-	283	mJ

[1] Continuous current is limited by package.

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate	 <p>TO-220AB (SOT78)</p>	
2	D	drain		
3	S	source		
mb	D	mounting base; connected to drain		

## 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PSMN3R9-60PS	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

## 7. Marking

Table 4. Marking codes

Type number	Marking code
PSMN3R9-60PS	PSMN3R9-60PS

## 8. Limiting values

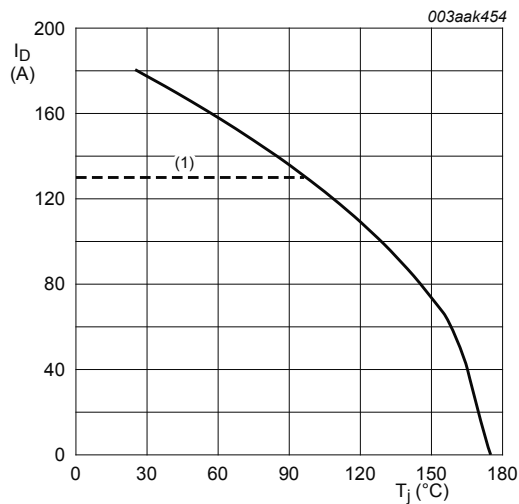
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{DS}$	drain-source voltage	$T_j \geq 25\text{ °C}$ ; $T_j \leq 175\text{ °C}$		-	60	V
$V_{DGR}$	drain-gate voltage	$R_{GS} = 20\text{ k}\Omega$		-	60	V
$V_{GS}$	gate-source voltage			-20	20	V
$I_D$	drain current	$T_{mb} = 25\text{ °C}$ ; $V_{GS} = 10\text{ V}$ ; Fig. 1	[1]	-	130	A
		$T_{mb} = 100\text{ °C}$ ; $V_{GS} = 10\text{ V}$ ; Fig. 1		-	127	A
$I_{DM}$	peak drain current	$T_{mb} = 25\text{ °C}$ ; pulsed; $t_p \leq 10\text{ }\mu\text{s}$ ; Fig. 4		-	705	A

Symbol	Parameter	Conditions		Min	Max	Unit
$P_{\text{tot}}$	total power dissipation	$T_{\text{mb}} = 25\text{ °C}$ ; <a href="#">Fig. 2</a>		-	263	W
$T_{\text{stg}}$	storage temperature			-55	175	°C
$T_{\text{j}}$	junction temperature			-55	175	°C
$T_{\text{sld(M)}}$	peak soldering temperature			-	260	°C
<b>Source-drain diode</b>						
$I_{\text{S}}$	source current	$T_{\text{mb}} = 25\text{ °C}$	<a href="#">[1]</a>	-	130	A
$I_{\text{SM}}$	peak source current	pulsed; $t_{\text{p}} \leq 10\text{ }\mu\text{s}$ ; $T_{\text{mb}} = 25\text{ °C}$		-	705	A
<b>Avalanche ruggedness</b>						
$E_{\text{DS(AL)S}}$	non-repetitive drain-source avalanche energy	$I_{\text{D}} = 130\text{ A}$ ; $V_{\text{sup}} \leq 60\text{ V}$ ; $R_{\text{GS}} = 50\text{ }\Omega$ ; $V_{\text{GS}} = 10\text{ V}$ ; $T_{\text{j(init)}} = 25\text{ °C}$ ; unclamped; <a href="#">Fig. 3</a>		-	283	mJ

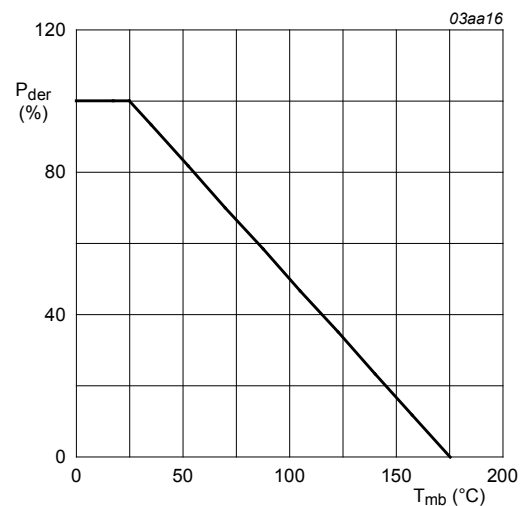
[1] Continuous current is limited by package.



**Fig. 1. Continuous drain current as a function of mounting base temperature**

$$V_{\text{GS}} \geq 10\text{ V}$$

(1) Capped at 130 A due to package.



**Fig. 2. Normalized total power dissipation as a function of mounting base temperature**

$$P_{\text{der}} = \frac{P_{\text{tot}}}{P_{\text{tot}(25\text{ °C})}} \times 100\%$$

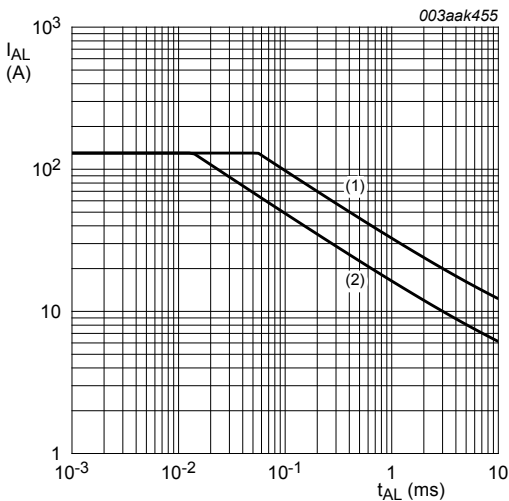


Fig. 3. Single pulse avalanche rating; avalanche current as a function of avalanche time

(1)  $T_j(jnt) = 25^\circ C$ ; (2)  $T_j(jnt) = 100^\circ C$

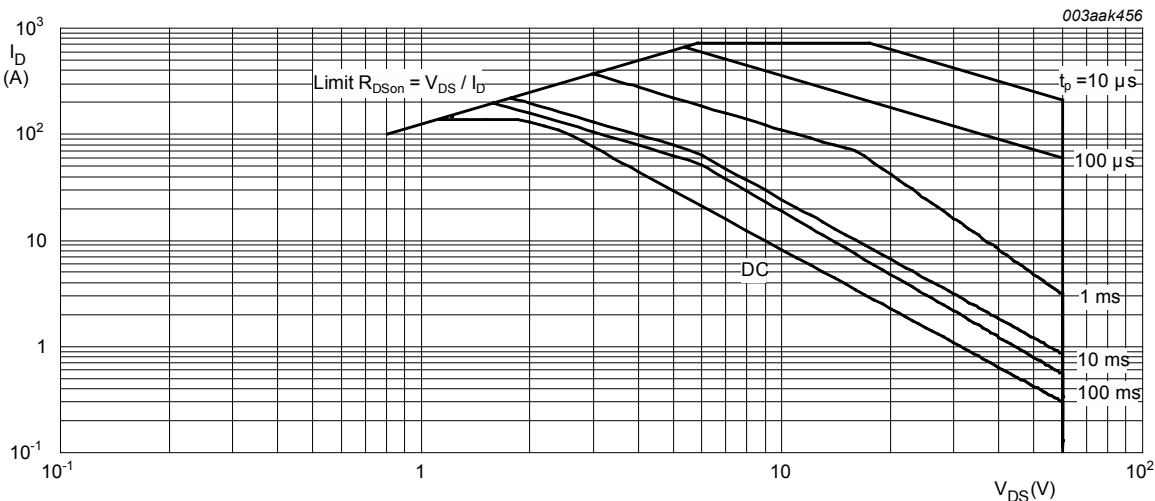


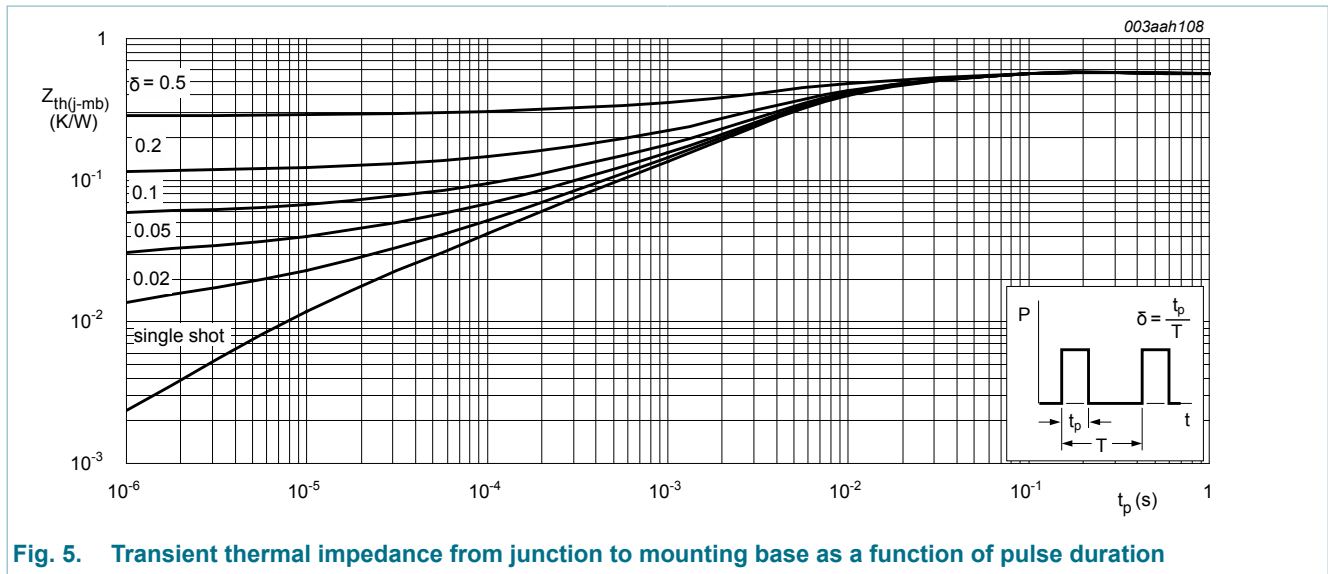
Fig. 4. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

$T_{mb} = 25^\circ C$ ;  $I_{DM}$  is a single pulse

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Fig. 5	-	0.49	0.57	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	vertical in still air	-	60	-	K/W



## 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static characteristics</b>						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 250 \mu A$ ; $V_{GS} = 0 V$ ; $T_J = 25 ^\circ C$	60	-	-	V
		$I_D = 250 \mu A$ ; $V_{GS} = 0 V$ ; $T_J = -55 ^\circ C$	54	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1 mA$ ; $V_{DS} = V_{GS}$ ; $T_J = 25 ^\circ C$ ; <a href="#">Fig. 9</a> ; <a href="#">Fig. 10</a>	2.4	3	4	V
		$I_D = 1 mA$ ; $V_{DS} = V_{GS}$ ; $T_J = 175 ^\circ C$ ; <a href="#">Fig. 9</a>	1	-	-	V
		$I_D = 1 mA$ ; $V_{DS} = V_{GS}$ ; $T_J = -55 ^\circ C$ ; <a href="#">Fig. 9</a>	-	-	4.5	V
$I_{DSS}$	drain leakage current	$V_{DS} = 60 V$ ; $V_{GS} = 0 V$ ; $T_J = 175 ^\circ C$	-	-	500	$\mu A$
		$V_{DS} = 60 V$ ; $V_{GS} = 0 V$ ; $T_J = 25 ^\circ C$	-	0.07	1	$\mu A$
$I_{GSS}$	gate leakage current	$V_{GS} = 20 V$ ; $V_{DS} = 0 V$ ; $T_J = 25 ^\circ C$	-	2	100	nA
		$V_{GS} = -20 V$ ; $V_{DS} = 0 V$ ; $T_J = 25 ^\circ C$	-	2	100	nA
$R_{DSon}$	drain-source on-state resistance	$V_{GS} = 10 V$ ; $I_D = 25 A$ ; $T_J = 25 ^\circ C$ ; <a href="#">Fig. 11</a>	-	2.94	3.9	mΩ
		$V_{GS} = 10 V$ ; $I_D = 25 A$ ; $T_J = 175 ^\circ C$ ; <a href="#">Fig. 11</a> ; <a href="#">Fig. 12</a>	-	-	8.5	mΩ
$R_G$	gate resistance	$f = 1 MHz$	0.35	0.7	1.4	Ω
<b>Dynamic characteristics</b>						
$Q_{G(tot)}$	total gate charge	$I_D = 25 A$ ; $V_{DS} = 48 V$ ; $V_{GS} = 10 V$ ; <a href="#">Fig. 13</a> ; <a href="#">Fig. 14</a>	-	103	-	nC
$Q_{GS}$	gate-source charge		-	25.1	-	nC

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Q <sub>GD</sub>	gate-drain charge			-	33	-	nC
C <sub>iss</sub>	input capacitance	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 25 V; f = 1 MHz; T <sub>j</sub> = 25 °C; <a href="#">Fig. 15</a>		-	5600	-	pF
C <sub>oss</sub>	output capacitance			-	740	-	pF
C <sub>rss</sub>	reverse transfer capacitance			-	460	-	pF
t <sub>d(on)</sub>	turn-on delay time	V <sub>DS</sub> = 45 V; R <sub>L</sub> = 1.8 Ω; V <sub>GS</sub> = 10 V; R <sub>G(ext)</sub> = 5 Ω		-	25.3	-	ns
t <sub>r</sub>	rise time			-	41.4	-	ns
t <sub>d(off)</sub>	turn-off delay time			-	62.7	-	ns
t <sub>f</sub>	fall time			-	45	-	ns
Source-drain diode							
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 25 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; <a href="#">Fig. 16</a>		-	0.8	1.2	V
t <sub>rr</sub>	reverse recovery time	I <sub>S</sub> = 20 A; dI <sub>S</sub> /dt = -100 A/μs; V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 25 V		-	39	-	ns
Q <sub>r</sub>	recovered charge			-	51	-	nC

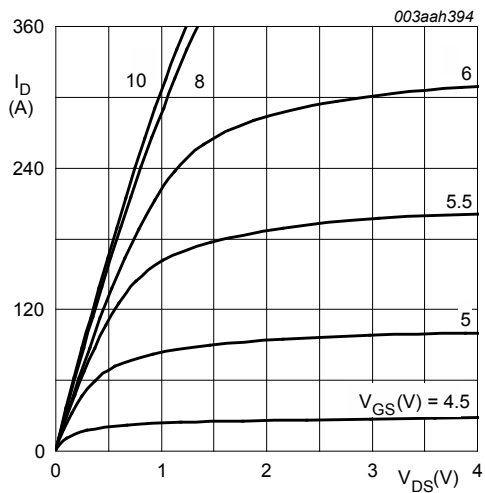


Fig. 6. Output characteristics; drain current as a function of drain-source voltage; typical values

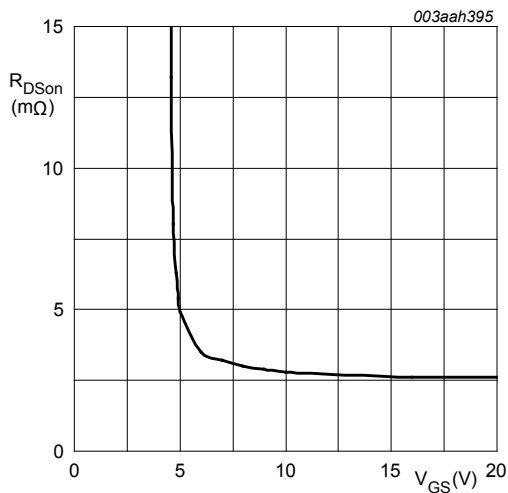


Fig. 7. Drain-source on-state resistance as a function of gate-source voltage; typical values

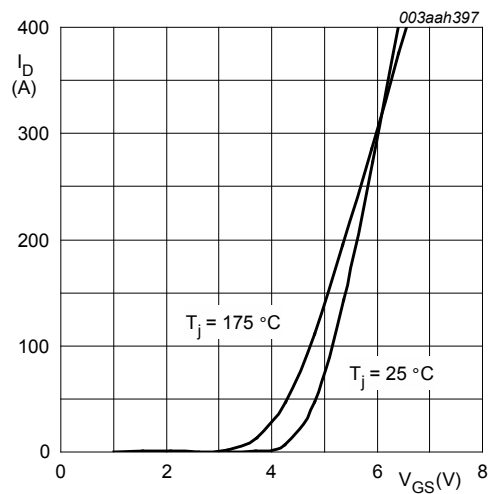


Fig. 8. Transfer characteristics; drain current as a function of gate-source voltage; typical values

$V_{DS} = 10\text{ V}$

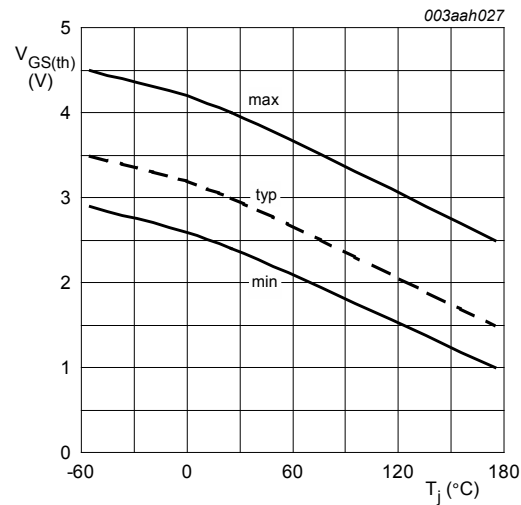


Fig. 9. Gate-source threshold voltage as a function of junction temperature

$I_D = 1\text{ mA}; V_{DS} = V_{GS}$

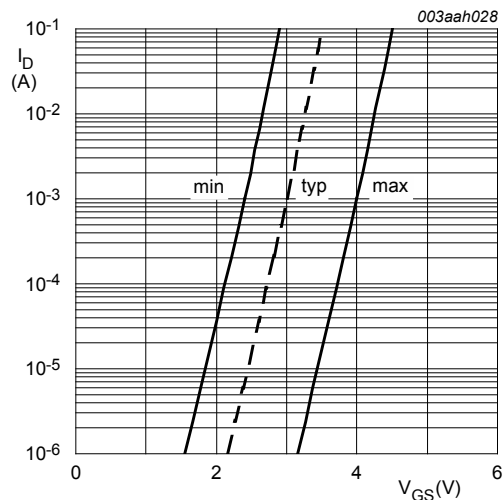


Fig. 10. Sub-threshold drain current as a function of gate-source voltage

$T_J = 25\text{ }^{\circ}\text{C}; V_{DS} = 5\text{ V}$

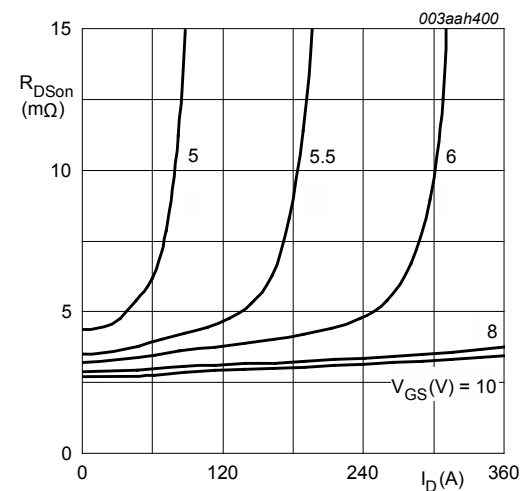


Fig. 11. Drain-source on-state resistance as a function of drain current; typical values

$T_J = 25\text{ }^{\circ}\text{C}; t_p = 300\text{ }\mu\text{s}$

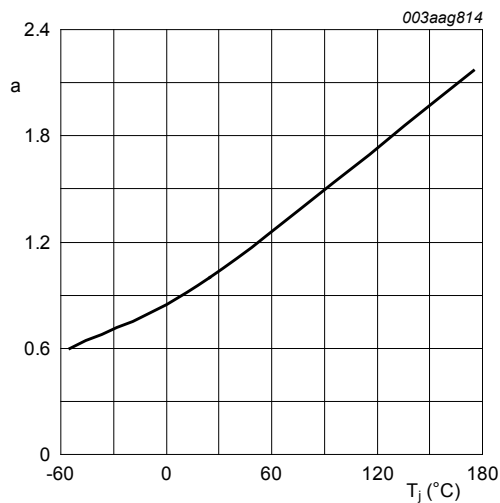


Fig. 12. Normalized drain-source on-state resistance factor as a function of junction temperature

$$a = \frac{R_{DSon}}{R_{DSon}(25\text{ °C})}$$

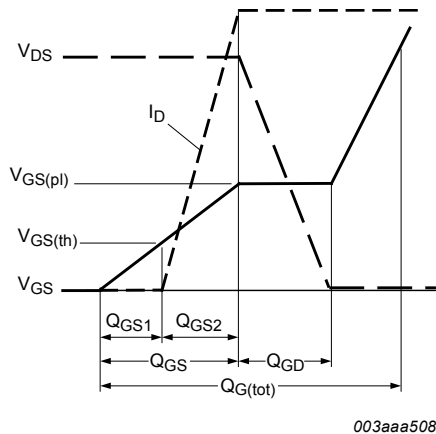


Fig. 13. Gate charge waveform definitions

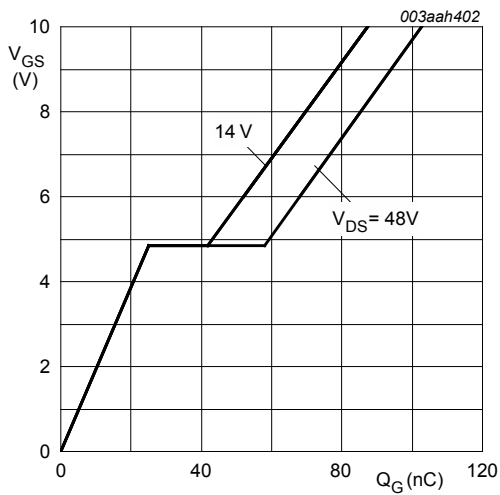


Fig. 14. Gate-source voltage as a function of gate charge; typical values

$$T_j = 25\text{ °C}; I_D = 25\text{ A}$$

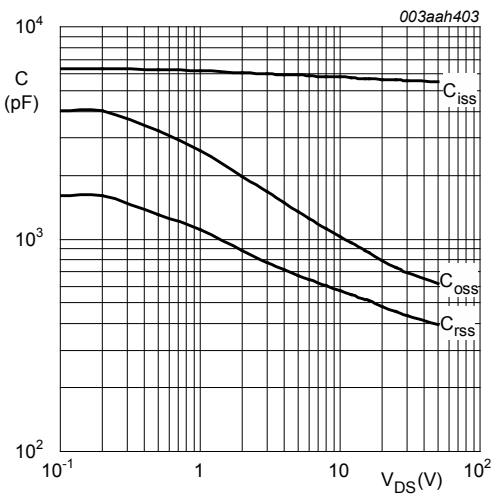


Fig. 15. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

$$V_{GS} = 0\text{ V}; f = 1\text{ MHz}$$



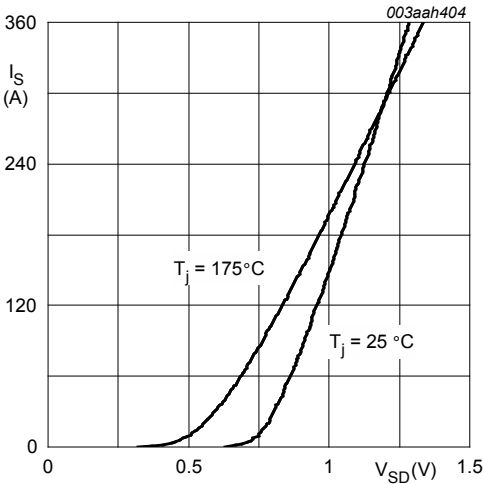


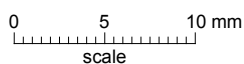
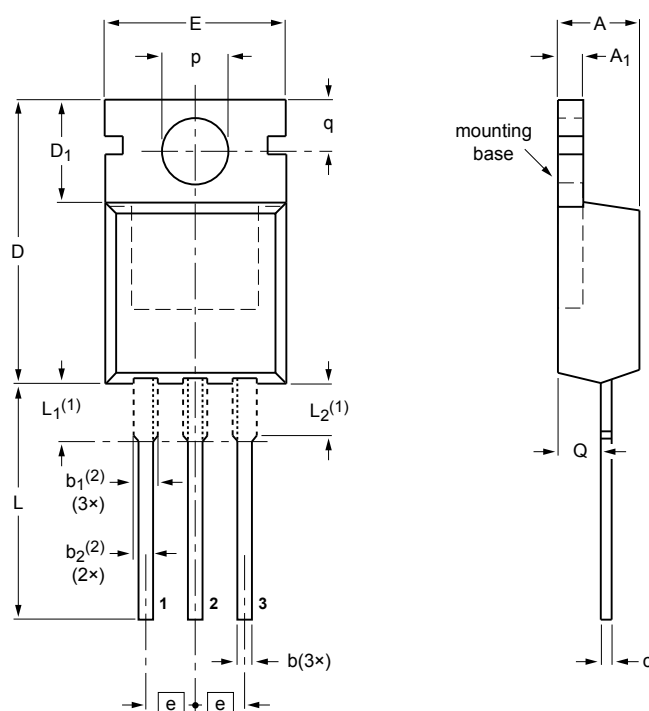
Fig. 16. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values

$V_{GS} = 0V$

## 11. Package outline

**Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB**

**SOT78**




**DIMENSIONS** (mm are the original dimensions)

UNIT	A	A <sub>1</sub>	b	b <sub>1</sub> (2)	b <sub>2</sub> (2)	c	D	D <sub>1</sub>	E	e	L	L <sub>1</sub> (1)	L <sub>2</sub> (1) max.	p	q	Q
mm	4.7	1.40	0.9	1.6	1.3	0.7	16.0	6.6	10.3	2.54	15.0	3.30	3.0	3.8	3.0	2.6
	4.1	1.25	0.6	1.0	1.0	0.4	15.2	5.9	9.7		12.8	2.79		3.5	2.7	2.2

## Notes

1. Lead shoulder designs may vary.
2. Dimension includes excess dambar.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT78		3-lead TO-220AB	SC-46			08-04-23- 08-06-13

**Fig. 17. Package outline TO-220AB (SOT78)**

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Document status [1][2]	Product status [3]	Definition
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Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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**Наши контакты:**

**Телефон:** +7 812 627 14 35

**Электронная почта:** [sales@st-electron.ru](mailto:sales@st-electron.ru)

**Адрес:** 198099, Санкт-Петербург,  
Промышленная ул, дом № 19, литера Н,  
помещение 100-Н Офис 331